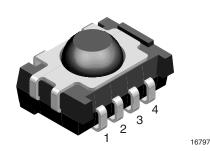


IR Mid Range Proximity Sensor



MECHANICAL DATA

Pinning

 $1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$

ORDERING CODE

Taping:

TSSP6P38TT - top view taped TSSP6P38TR - side view taped

DESCRIPTION

The TSSP6P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

FEATURES

- · Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- 940 nm peak wavelength
- · Photo detector and preamplifier in one package
- · Low supply current
- · Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

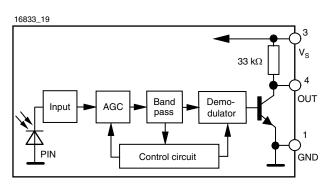
- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- · Reflective sensors for toilet flush
- Navigational sensor for robotics

PARTS TABLE	
Carrier frequency 38 kHz	TSSP6P38
Package	Panhead
Pinning	1 = GND, 2 = N.C., 3 = V _S , 4 = OUT
Dimensions (mm)	7.5 W x 5.3 H x 4.0 D
Mounting	SMD
Application	Proximity sensors

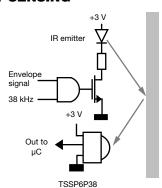
Note

• Other frequencies available by request

BLOCK DIAGRAM



PROXIMITY SENSING







RoHS COMPLIANT

FREE

GREEN (5-2008) www.vishay.com

Vishay Semiconductors

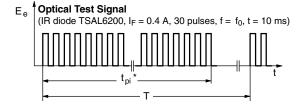
ABSOLUTE MAXIMUM RA	IMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage (pin 3)		Vs	-0.3 to +6	V
Supply current (pin 3)		Is	5	mA
Output voltage (pin 4)		Vo	-0.3 to 5.5	V
Voltage at output to supply		V _S - V _O	-0.3 to (V _S + 0.3)	V
Output current (pin 4)		I _O	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

• Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPT	ICAL CHARACTERISTICS	$(T_{amb} = 25)^{\circ}$	°C, unless o	otherwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 2)	$E_e = 0, V_S = 5 V$	I _{SD}	0.55	0.7	0.9	mA
Supply current (pin 3)	E _v = 40 klx, sunlight	I _{SH}	-	0.8	-	mA
Supply voltage		V _S	2.7	-	5.5	V
Receiving distance	Direct line of sight, test signal see fig. 1, IR diode TSAL6200, I _F = 250 mA	d	-	40	-	m
Output voltage low (pin 4)	I _{OSL} = 0.5 mA, E _e = 0.7 mW/m ² , test signal see fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ f_o , test signal see fig. 1	E _{e min.}	-	0.2	0.4	mW/m²
Maximum irradiance	t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ f_o , test signal see fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half receiving distance	Ψ1/2	-	± 45	-	deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



* $t_{0i} \ge 10/f_0$ is recommended for optimal function

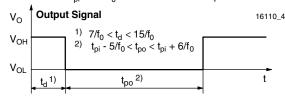


Fig. 1 - Output Active Low

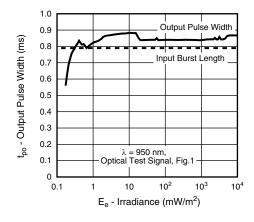


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



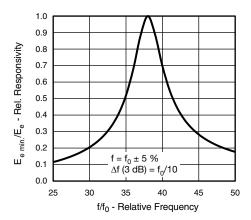


Fig. 3 - Frequency Dependence of Responsivity

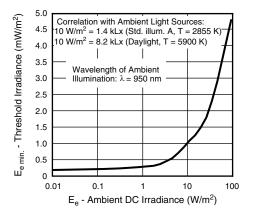


Fig. 4 - Sensitivity in Bright Ambient

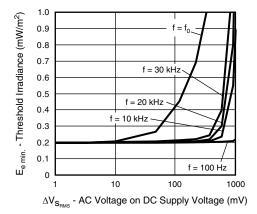


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

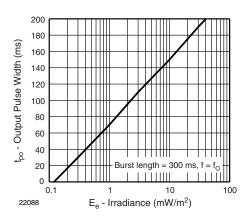


Fig. 6 - Maximum Output Pulse Width vs. Irradiance

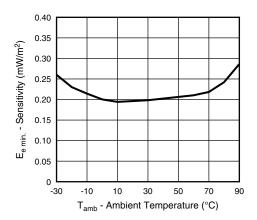


Fig. 7 - Sensitivity vs. Ambient Temperature

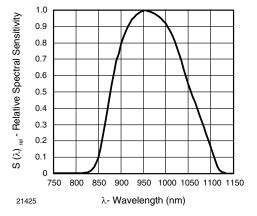


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength



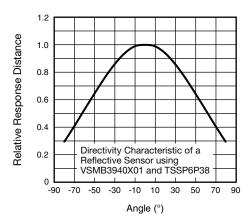


Fig. 9 - Angle Characteristic

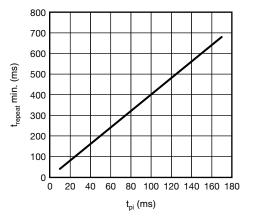


Fig. 10 - Max. Rate of Bursts

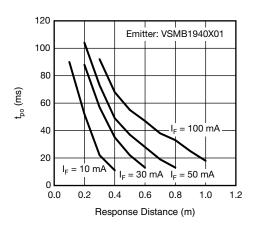


Fig. 11 - t_{po} vs. Distance Kodak Gray Card Plus 15 %

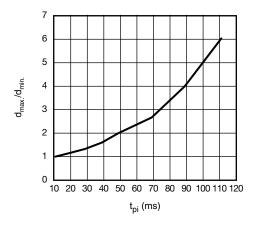
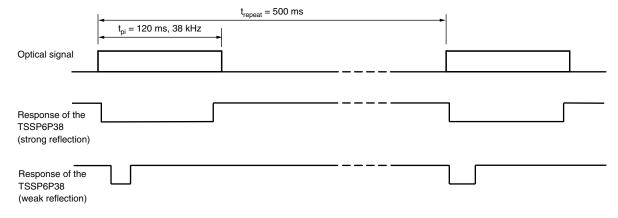


Fig. 12 - Dynamic Range of Sensor vs. tpi

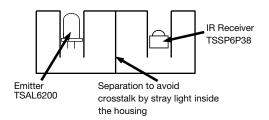
The typical application of the TSSP6P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:





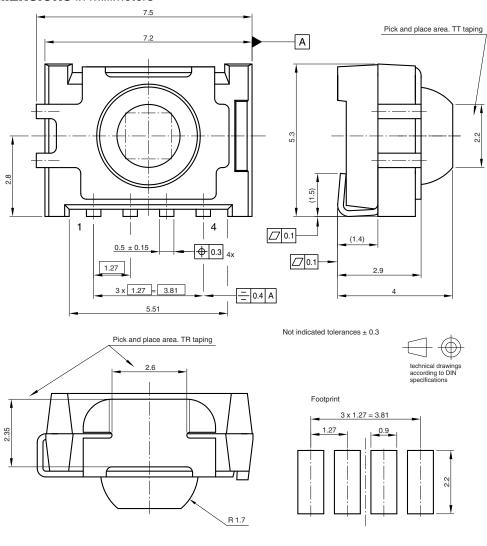
Example for a sensor hardware:



There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP6P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09



ASSEMBLY INSTRUCTIONS

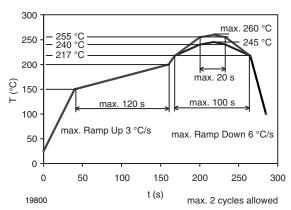
Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

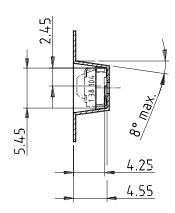
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSSP..TT DIMENSIONS in millimeters

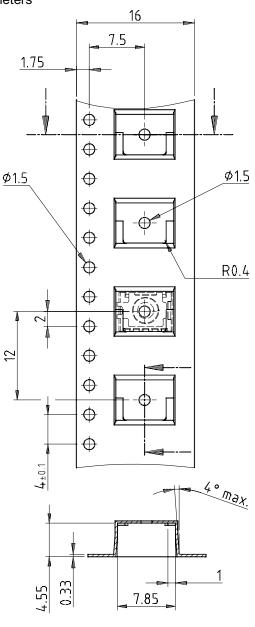




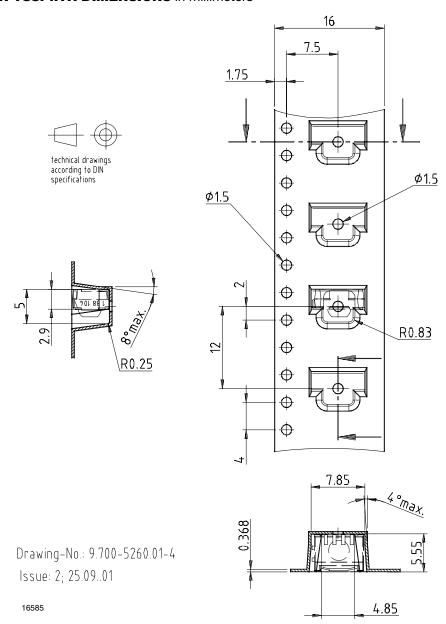
Drawing-No.: 9.700-5259.01-4

Issue: 1; 05.09.01

16584

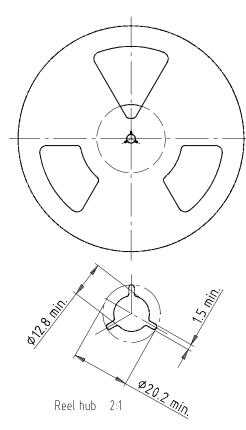


TAPING VERSION TSSP..TR DIMENSIONS in millimeters



Rev. 1.8, 14-Apr-16 8 Document Number: 82475

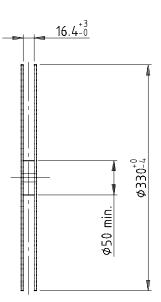
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

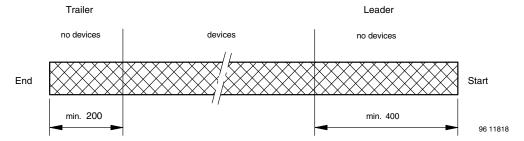
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

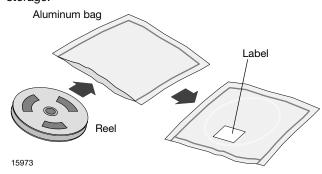
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.



PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

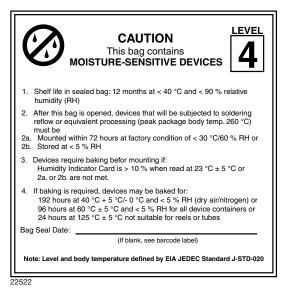
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC $^{\circledR}$ standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags





ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



22645



Tape and Reel Standards for Surface-Mount IR Receiver Modules

Vishay Semiconductor surface-mount IR receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Type
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

A. Panhead: quantity per reel:

TT, top view package, 1190 pcs

TR, side view package, 1120 pcs

B. Heimdall: quantity per reel:

TT, top view package, 2200 pcs

TR, side view package, 2300 pcs

C. Heimdall without lens: quantity per reel:

WTT, top view package, 2200 pcs

WTR, side view package, 2300 pcs

D. Belobog: quantity per reel:

TT1, top view package, 1800 pcs

TT2, top view package, 7000 pcs

E. Belobog with shield: quantity per reel:

TT1, top view package, 1500 pcs

TT2, top view package, 5000 pcs

F. Minimold DF1P: quantity per reel:

DF1P, 1100 pcs

G. TVCastSMD TR: quantity per reel:

TR, side view package, 2200 pcs

ORDER DESIGNATION

The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

TSOP6238TR (reel packing)

TSOP75238TR (reel packing)

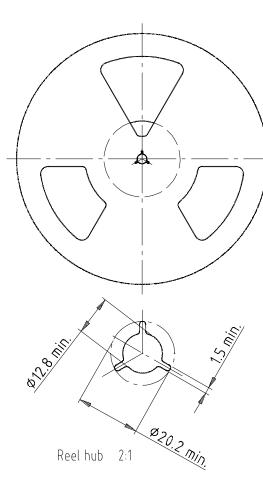
TSOP75338WTT (reel packing)

TSOP57438TT1 (reel packing)

TSOP57238HTT1 (reel packing)

TSOP39438TR (reel packing)

REEL DIMENSIONS FOR PANHEAD, HEIMDALL, AND TVCASTSMD TR in millimeters



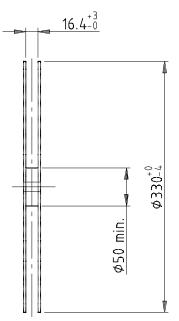
Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16

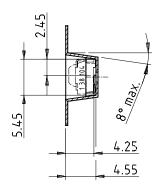


technical drawings according to DIN specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

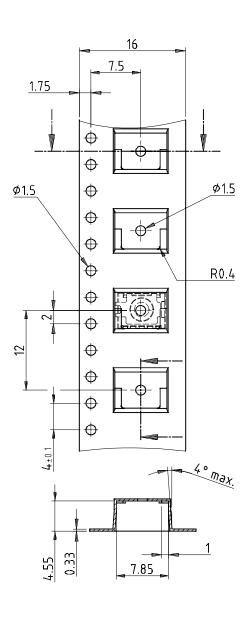
A. Panhead (TSOP36...TT, TSSP....TT, TSOP6...TT)





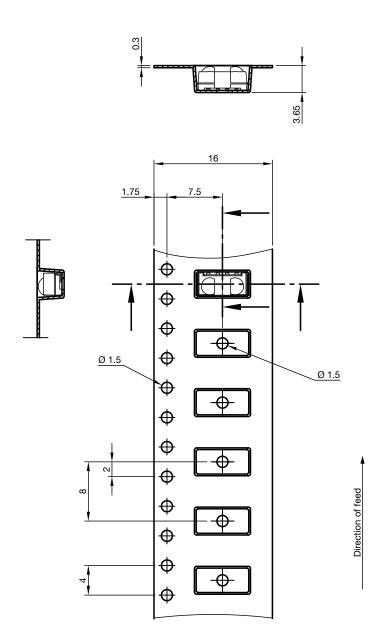
Drawing-No.: 9.700-5259.01-4 Issue: 1; 05.09.01

16584



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75...TT, TSOP77...TT, TSSP77...TT)



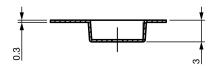
Drawing-No.: 9.700-5338.01-4

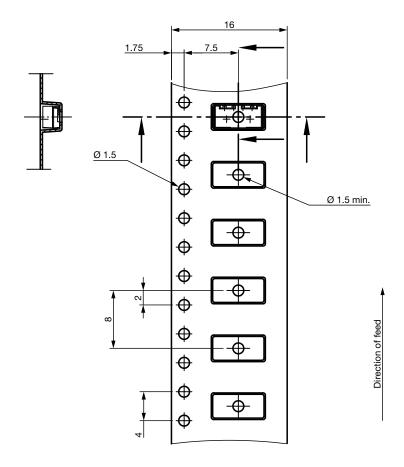
Issue: 4; 12.06.13

technical drawings according to DIN specifications

TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTT, TSOP77...WTT, TSSP77...WTT)





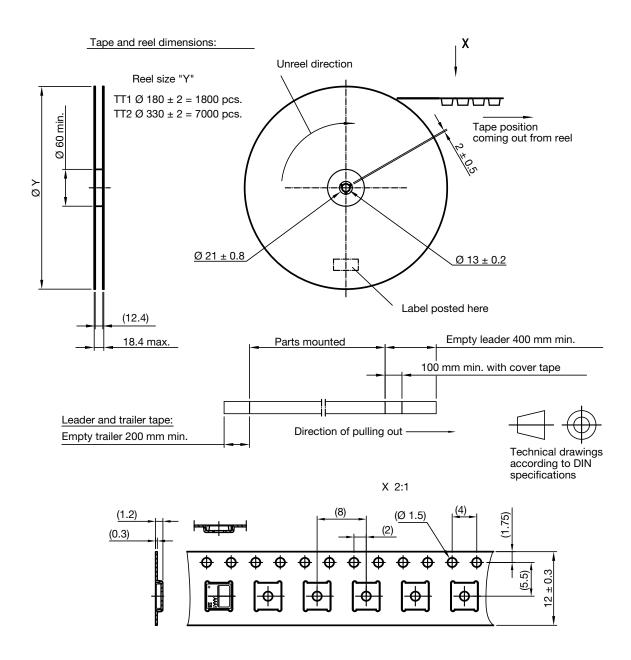
Drawing-No.: 9.700-5341.01-4

Issue: 3; 06.10.15

technical drawings according to DIN specifications

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

D. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



Drawing-No.: 9.700-5347.01-4

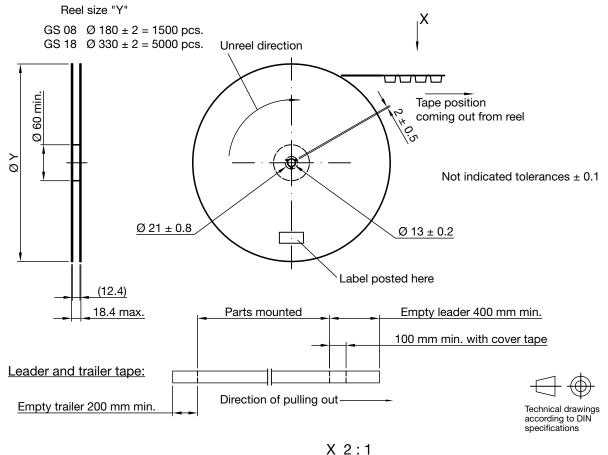
Issue: 1; 14.11.11

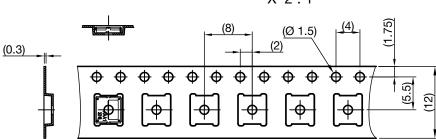
Not indicated tolerances ± 0.1

TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

E. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:





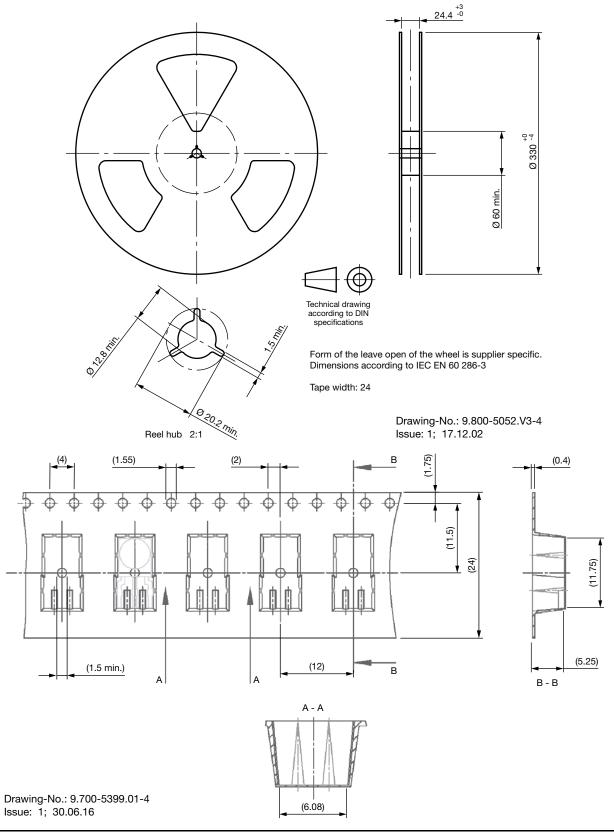
Drawing-No.: 9.700-5380.01-4

Issue: 1; 28.10.13



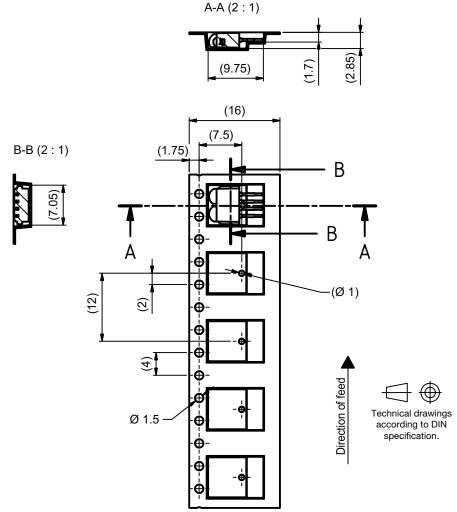
TAPING VERSION TSOP..DF1P (SIDE VIEW) DIMENSIONS in millimeters

F. Minimold DF1P (TSOP33...DF1P, TSOP53...DF1P)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

G. TVCastSMD TR (TSOP59...TR, TSOP39...TR)

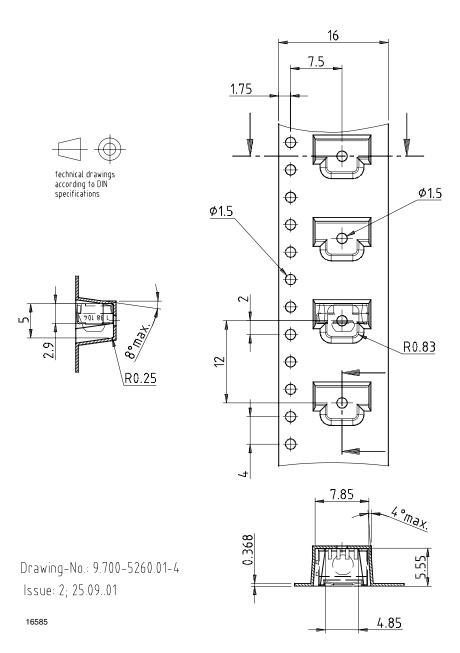


Drawing-No.: GO-100220.10_Z

Issue B: 08.02.17

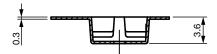
TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

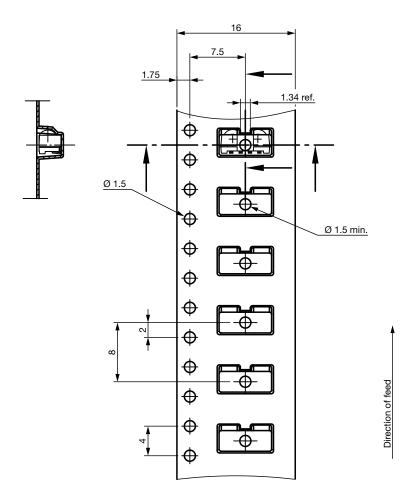
A. Panhead (TSOP36...TR, TSSP6...TR, TSOP6...TR)



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall (TSOP75..., TSOP77..., TSSP7....)





Drawing-No.: 9.700-5337.01-4

Issue: 2; 06.10.15

technical drawings according to DIN specifications

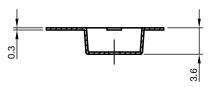
Drawing-No.: 9.700-5342.01-4

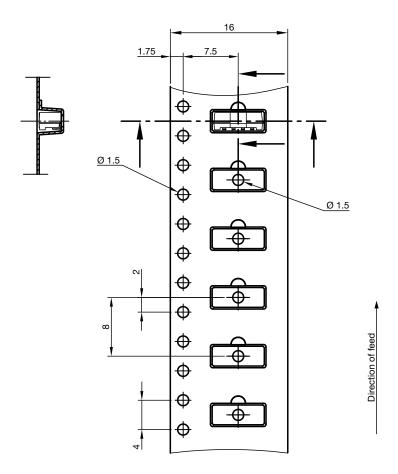
Issue: 2; 12.06.13

Vishay Semiconductors

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall without lens (TSOP75...WTR, TSOP77...WTR, TSSP...WTR)

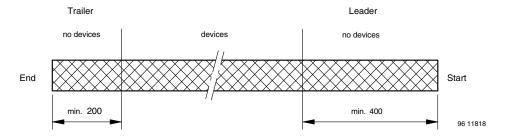




technical drawings according to DIN specifications



LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

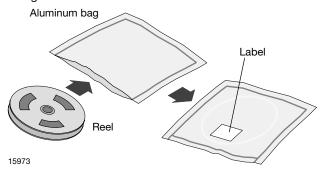
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

PLAIN WRITING	ABBREVIATION	LENGTH	
Item-description	-	18	
Item-number	INO	8	
Selection-code	SEL	3	
LOT-/serial-number	BATCH	10	
Data-code	COD	3 (YWW)	
Plant-code	PTC	2	
Quantity	QTY	8	
Accepted by	ACC	-	
Packed by	PCK	-	
Mixed code indicator	MIXED CODE	-	
Origin	xxxxxxx+	Company logo	
LONG BAR CODE TOP	TYPE	LENGTH	
Item-number	N	8	
Plant-code	N	2	
Sequence-number	X	3	
Quantity	N	8	
Total length	-	21	
SHORT BAR CODE TOP	TYPE	LENGTH	
Selection-code	X	3	
Data-code	N	3	
Batch-number	X	10	
Filter	-	1	
Total length	-	17	



DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

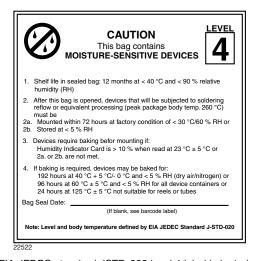
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC $^{\!0}\!\!\!\!\!^{^{^{}}}$ standard JSTD-020 level 4 label is included on all dry bags.



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

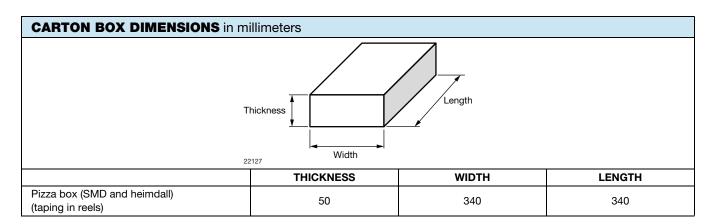
VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



OUTER PACKAGING

The sealed reel is packed into a pizza box.





Legal Disclaimer Notice

Vishay

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